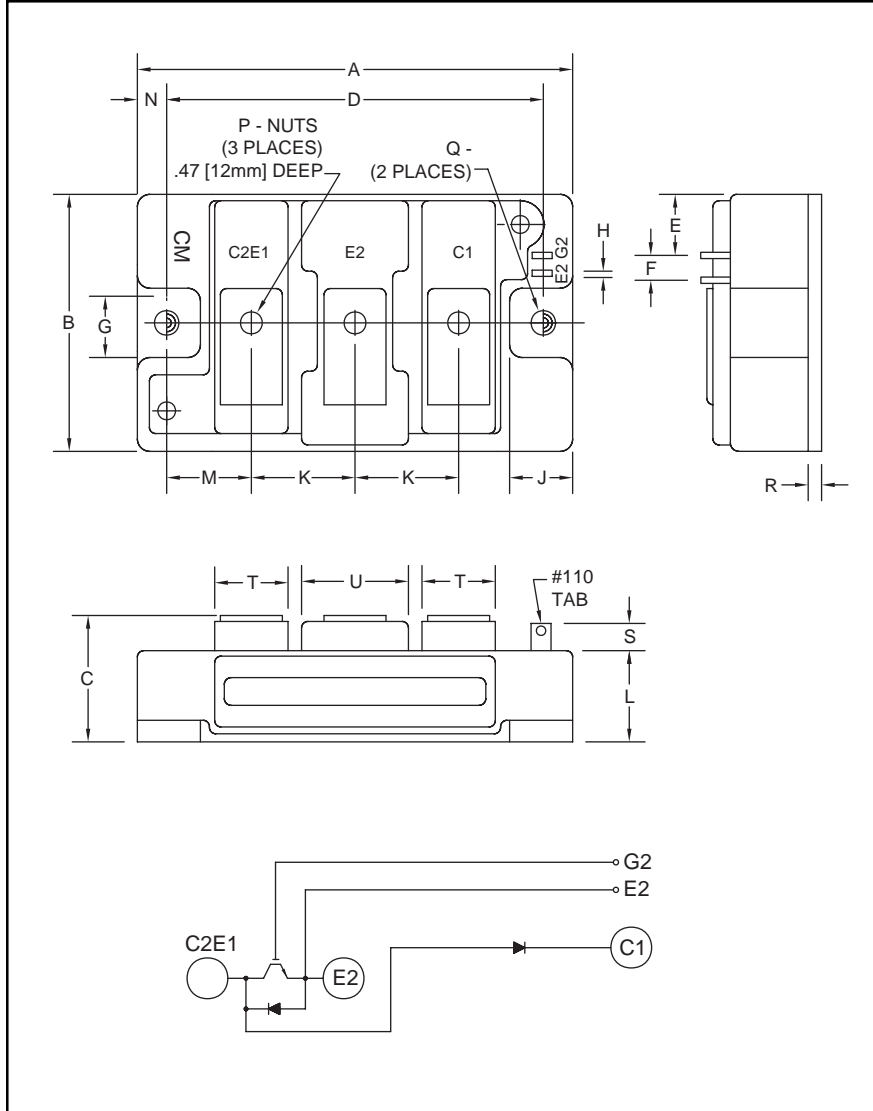


Chopper IGBTMOD™ U-Series Module 200 Amperes/600 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	3.70	94.0
B	1.89	48.0
C	1.18 +0.04/-0.02	30.0 +1.0/-0.5
D	3.15±0.01	80.0±0.25
E	0.43	11.0
F	0.16	4.0
G	0.51	13.0
H	0.02	0.5
J	0.53	13.5
K	0.91	23.0

Dimensions	Inches	Millimeters
L	0.84	21.2
M	0.67	17.0
N	0.28	7.0
P	M5	M5
Q	0.26 Dia.	6.5 Dia.
R	0.02	4.0
S	0.30	7.5
T	0.63	16.0
U	0.98	25.0



Description:

Powerex Chopper IGBTMOD™ Modules are designed for use in switching applications. Each module consists of one IGBT Transistor having a reverse-connected super-fast recovery free-wheel diode and an anode-collector connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- Low Drive Power
- Low $V_{CE(sat)}$
- Discrete Super-Fast Recovery Free-Wheel Diode
- High Frequency Operation (15-20kHz)
- Isolated Baseplate for Easy Heat Sinking

Applications:

- DC Motor Control
- Boost Regulator

Ordering Information:

Example: Select the complete module number you desire from the table - i.e. CM200E3U-12H is a 600V (V_{CES}), 200 Ampere Chopper IGBTMOD™ Power Module.

Type	Current Rating Amperes	V_{CES} Volts (x 50)
CM	200	12

CM200E3U-12H

Chopper IGBTMOD™ U-Series Module

200 Amperes/600 Volts

Absolute Maximum Ratings, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Ratings	Symbol	CM200E3U-12H	Units
Junction Temperature	T_j	-40 to 150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 to 125	$^\circ\text{C}$
Collector-Emitter Voltage (G-E SHORT)	V_{CES}	600	Volts
Gate-Emitter Voltage (C-E SHORT)	V_{GES}	± 20	Volts
Collector Current ($T_c = 25^\circ\text{C}$)	I_c	200	Amperes
Peak Collector Current	I_{CM}	400*	Amperes
Emitter Current** ($T_c = 25^\circ\text{C}$)	I_E	200	Amperes
Peak Emitter Current**	I_{EM}	400*	Amperes
Maximum Collector Dissipation ($T_c = 25^\circ\text{C}$, $T_j \leq 150^\circ\text{C}$)	P_c	650	Watts
Mounting Torque, M5 Main Terminal	–	31	in-lb
Mounting Torque, M6 Mounting	–	40	in-lb
Weight	–	310	Grams
Isolation Voltage (Main Terminal to Baseplate, AC 1 min.)	V_{iso}	2500	Volts

* Pulse width and repetition rate should be such that the device junction temperature (T_j) does not exceed $T_{j(\text{max})}$ rating.

**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

Static Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	I_{CES}	$V_{\text{CE}} = V_{\text{CES}}$, $V_{\text{GE}} = 0\text{V}$	–	–	1	mA
Gate Leakage Voltage	I_{GES}	$V_{\text{GE}} = V_{\text{GES}}$, $V_{\text{CE}} = 0\text{V}$	–	–	0.5	μA
Gate-Emitter Threshold Voltage	$V_{\text{GE(th)}}$	$I_c = 20\text{mA}$, $V_{\text{CE}} = 10\text{V}$	4.5	6	7.5	Volts
Collector-Emitter Saturation Voltage	$V_{\text{CE(sat)}}$	$I_c = 200\text{A}$, $V_{\text{GE}} = 15\text{V}$, $T_j = 25^\circ\text{C}$	–	2.4	3.0	Volts
		$I_c = 200\text{A}$, $V_{\text{GE}} = 15\text{V}$, $T_j = 125^\circ\text{C}$	–	2.6	–	Volts
Total Gate Charge	Q_G	$V_{\text{CC}} = 300\text{V}$, $I_c = 200\text{A}$, $V_{\text{GE}} = 15\text{V}$	–	400	–	nC
Emitter-Collector Voltage**	V_{EC}	$I_E = 200\text{A}$, $V_{\text{GE}} = 0\text{V}$	–	–	2.6	Volts
Emitter-Collector Voltage	V_{FM}	$I_F = 200\text{A}$, Clamp Diode Part	–	–	2.6	Volts

**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

Dynamic Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

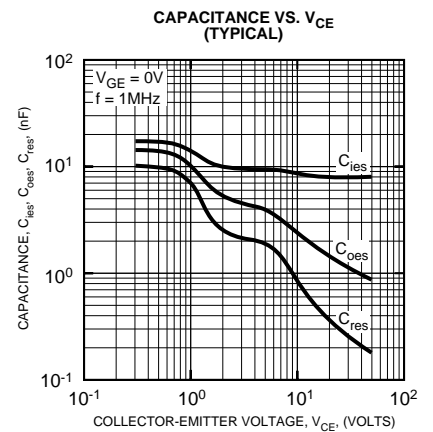
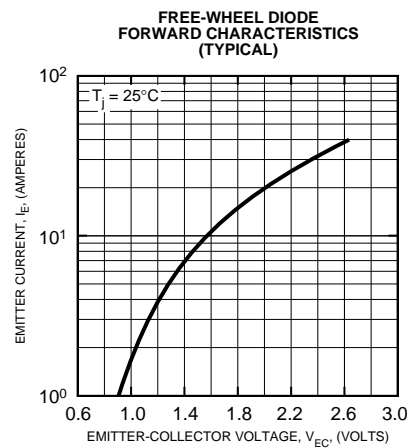
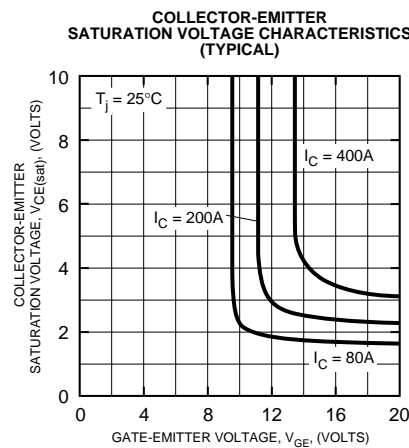
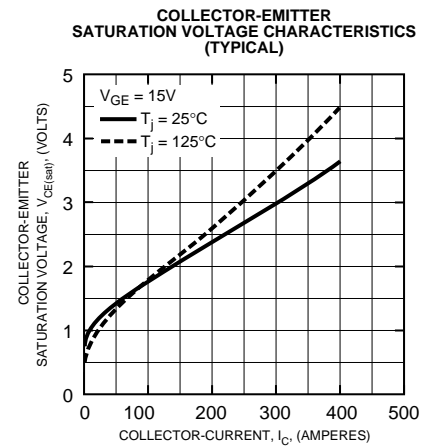
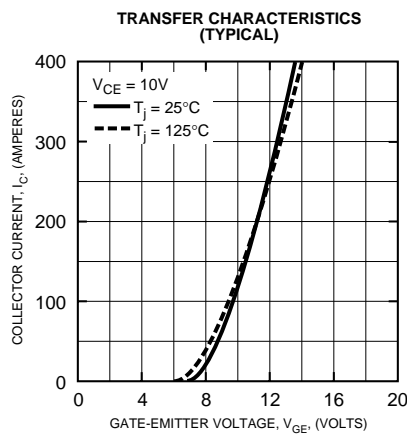
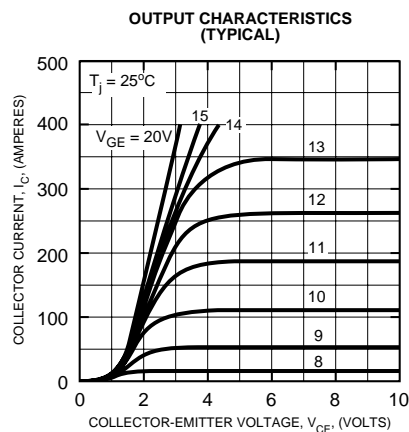
Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units	
Input Capacitance	C_{ies}		–	–	17.6	nf	
Output Capacitance	C_{oes}	$V_{\text{CE}} = 10\text{V}$, $V_{\text{GE}} = 0\text{V}$	–	–	9.6	nf	
Reverse Transfer Capacitance	C_{res}		–	–	2.6	nf	
Resistive	Turn-on Delay Time	$t_{\text{d(on)}}$	$V_{\text{CC}} = 300\text{V}$, $I_c = 200\text{A}$,	–	–	150	ns
Load	Rise Time	t_r		–	–	400	ns
Switch	Turn-off Delay Time	$t_{\text{d(off)}}$	$R_G = 3.1\Omega$, Resistive	–	–	300	ns
Times	Fall Time	t_f		–	–	300	ns
Diode Reverse Recovery Time**	t_{rr}	$I_E = 200\text{A}$, $di_E/dt = -400\text{A}/\mu\text{s}$	–	–	160	ns	
Diode Reverse Recovery Charge**	Q_{rr}	$I_E = 200\text{A}$, $di_E/dt = -400\text{A}/\mu\text{s}$	–	0.48	–	μC	
Diode Reverse Recovery Time	t_{rr}	$I_F = 200\text{A}$, Clamp Diode Part	–	–	160	ns	
Diode Reverse Recovery Charge	Q_{rr}	$di_F/dt = -400\text{A}/\mu\text{s}$	–	0.48	–	μC	

**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

CM200E3U-12H
Chopper IGBTMOD™ U-Series Module
 200 Amperes/600 Volts

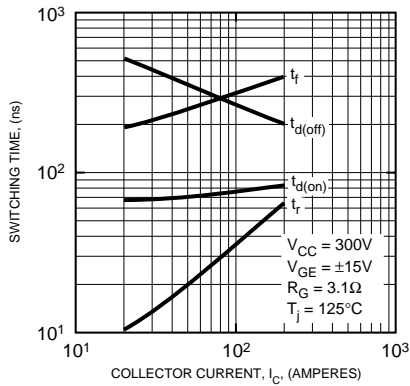
Thermal and Mechanical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{th(j-c)Q}$	Per IGBT	–	–	0.19	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)D}$	Per FWDi	–	–	0.35	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)}$	Clamp Diode Part	–	–	0.35	$^\circ\text{C/W}$
Contact Thermal Resistance	$R_{th(c-f)}$	Per Module, Thermal Grease Applied	–	0.035	–	$^\circ\text{C/W}$

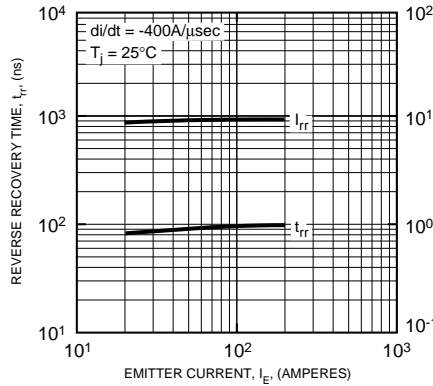


CM200E3U-12H
Chopper IGBTMOD™ U-Series Module
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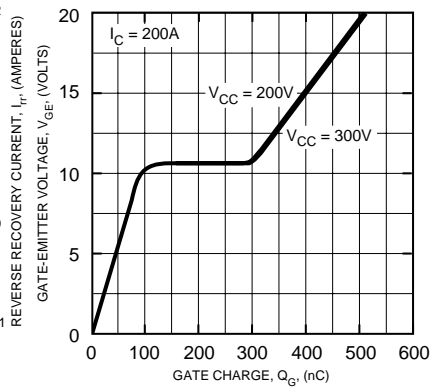
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)



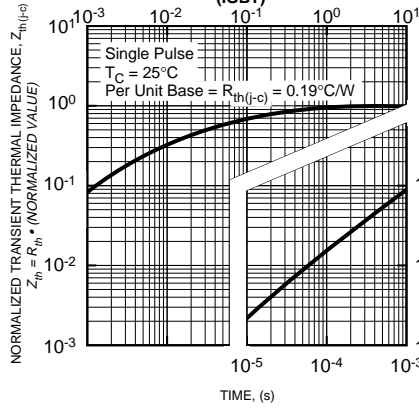
REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



GATE CHARGE, V_{GE}



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (IGBT)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (FWD)

